

RESPONSE UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
GROUP ART UNIT 1795

Docket Number
36856.1455

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hiroyuki KANBARA et al. Application No.: 10/596,000 Confirmation No.: 1561 Filing or 371(c) Date: January 17, 2007 Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	Art Unit: 1795 Examiner: A. Eoff
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AMENDMENT

DO NOT ENTER: /A.E./

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

07/07/2008

Entered with REF 7/29/08
mw 7/31/09

Sir:

In response to the Office Action dated April 2, 2008, please amend the above-identified application as follows:

- ☐ Amendments to the Specification begin on page of this paper.
- ☒ Amendments to the Claims are reflected in the listing of the claims which begins on page 2 of this paper.
- ☐ Amendments to the Drawings begin on page of this paper and include an attached replacement sheet. An Appendix including the amended drawing figures is attached following page of this paper.
- ☒ Remarks/Arguments begin on page 6 of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.